

Title (en)

ORGANIC ELECTRONIC DEVICES AND METHODS

Title (de)

ORGANISCHE ELEKTRONISCHE BAUELEMENTE UND VERFAHREN

Title (fr)

DISPOSITIFS ELECTRONIQUES ORGANIQUES ET PROCEDES ASSOCIES

Publication

EP 1836001 A2 20070926 (EN)

Application

EP 05856069 A 20051229

Priority

- US 2005047598 W 20051229
- US 64067304 P 20041230
- US 69488605 P 20050628

Abstract (en)

[origin: WO2006072066A2] Disclosed are methods of fabricating an organic electronic device, which includes dip coating layers, and the devices made therefrom.

IPC 8 full level

B05D 5/12 (2006.01); **B05D 1/18** (2006.01); **B05D 3/00** (2006.01); **H05H 1/32** (2006.01)

CPC (source: EP KR US)

B05D 3/02 (2013.01 - KR); **H05B 33/10** (2013.01 - KR); **H10K 30/00** (2023.02 - KR); **H10K 71/00** (2023.02 - KR); **H10K 71/12** (2023.02 - EP US); **H10K 71/15** (2023.02 - EP US); **H10K 85/1135** (2023.02 - EP US); **H10K 85/626** (2023.02 - EP US); **Y02E 10/549** (2013.01 - EP)

Designated contracting state (EPC)

DE GB

Designated extension state (EPC)

AL BA HR MK YU

DOCDB simple family (publication)

WO 2006072066 A2 20060706; WO 2006072066 A3 20070907; EP 1836001 A2 20070926; EP 1836001 A4 20090805; JP 2008527637 A 20080724; JP 5258302 B2 20130807; KR 101290012 B1 20130730; KR 20070112451 A 20071126; US 2010233383 A1 20100916; US 8481104 B2 20130709

DOCDB simple family (application)

US 2005047598 W 20051229; EP 05856069 A 20051229; JP 2007549686 A 20051229; KR 20077017362 A 20051229; US 79460405 A 20051229